LM136-5.0, LM236-5.0, LM336-5.0

*LM136-5.0/LM236-5.0/LM336-5.0 5.0V Reference Diode*
LM136-5.0/LM236-5.0/LM336-5.0
5.0V Reference Diode

General Description
The LM136-5.0/LM236-5.0/LM336-5.0 integrated circuits are precision 5.0V shunt regulator diodes. These monolithic IC voltage references operate as a low temperature coefficient 5.0V zener with 0.6Ω dynamic impedance. A third terminal on the LM136-5.0 allows the reference voltage and temperature coefficient to be trimmed easily.

The LM136-5.0 series is useful as a precision 5.0V low voltage reference for digital voltmeters, power supplies or op amp circuitry. The 5.0V makes it convenient to obtain a stable reference from low voltage supplies. Further, since the LM136-5.0 operates as a shunt regulator, it can be used as either a positive or negative voltage reference.

The LM136-5.0 is rated for operation over −55˚C to +125˚C while the LM236-5.0 is rated over a −25˚C to +85˚C temperature range. The LM336-5.0 is rated for operation over a 0˚C to +70˚C temperature range. See the connection diagrams for available packages. For applications requiring 2.5V see LM136-2.5.

Features
- Adjustable 4V to 6V
- Low temperature coefficient
- Wide operating current of 600 µA to 10 mA
- 0.6Ω dynamic impedance
- ± 1% initial tolerance available
- Guaranteed temperature stability
- Easily trimmed for minimum temperature drift
- Fast turn-on
- Three lead transistor package

Connection Diagrams

TO-92 Plastic Package

TO-46 Metal Can Package

SO Package

Order Number LM336Z-5.0 or LM336BZ-5.0
See NS Package Number Z03A

Order Number LM136H-5.0, LM136H-5.0/883, LM236H-5.0, LM136AH-5.0, LM136AH-5.0/883, or LM236AH-5.0
See NS Package Number H03H
Typical Applications

5.0V Reference

5.0V Reference with Minimum Temperature Coefficient

Trimmed 4V to 6V Reference with Temperature Coefficient Independent of Breakdown Voltage

† Adjust to 5.00V
* Any silicon signal diode

* Does not affect temperature coefficient

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Absolute Maximum Ratings (Note 1)
If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

- Reverse Current: 15mA
- Forward Current: 10mA
- Storage Temperature: −60˚C to +150˚C
- Operating Temperature Range (Note 2):
  - LM136-5.0: −55˚C to +150˚C
  - LM236-5.0: −25˚C to +85˚C
  - LM336-5.0: 0˚C to +70˚C

Soldering Information
- TO-92 Package (10 sec.): 260˚C
- TO-46 Package (10 sec.): 300˚C
- SO Package: Vapor Phase (60 sec.): 215˚C
- Infrared (15 sec.): 220˚C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" (appendix D) for other methods of soldering surface mount devices.

Electrical Characteristics (Note 3)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Conditions</th>
<th>LM136A-5.0/LM236A-5.0</th>
<th>LM136B-5.0/LM336B-5.0</th>
<th>LM336-5.0</th>
</tr>
</thead>
<tbody>
<tr>
<td>Reverse Breakdown Voltage</td>
<td>$T_A=25˚C$, $I_R=1\ mA$</td>
<td>Min 4.9 Typ 5.00 Max 5.1</td>
<td>Min 4.8 Typ 5.00 Max 5.2</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>$V_{RL}$ Adjusted 5.00V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>$I_R=1\ mA$, ($Figure\ 2$)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>$0˚C\leq T_A\leq 70˚C$ ($LM336B-5.0$)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>$-25˚C\leq T_A\leq 125˚C$ ($LM236-5.0$)</td>
<td>7 18</td>
<td>4 12</td>
<td>mV</td>
</tr>
<tr>
<td></td>
<td>$-55˚C\leq T_A\leq 125˚C$ ($LM136B-5.0$)</td>
<td>20 36</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>Reverse Breakdown Change With Current</td>
<td>$T_A=25˚C$, $600\ \mu A\leq I_R\leq 10\ mA$</td>
<td>6 12</td>
<td>6 20</td>
<td>mV</td>
</tr>
<tr>
<td>Reverse Dynamic Impedance</td>
<td>$T_A=25˚C$, $I_R=1\ mA$, $f=100\ Hz$</td>
<td>0.6 1.2</td>
<td>0.6 2</td>
<td>Ω</td>
</tr>
<tr>
<td>Temperature Stability</td>
<td>$V_{R}$ Adjusted 5.00V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>$I_R=1\ mA$, ($Figure\ 2$)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>$0˚C\leq T_A\leq 70˚C$ ($LM336B-5.0$)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>$-25˚C\leq T_A\leq 125˚C$ ($LM236-5.0$)</td>
<td>7 18</td>
<td>4 12</td>
<td>mV</td>
</tr>
<tr>
<td></td>
<td>$-55˚C\leq T_A\leq 125˚C$ ($LM136B-5.0$)</td>
<td>20 36</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>Reverse Breakdown Change With Current</td>
<td>$600\ \mu A\leq I_R\leq 10\ mA$</td>
<td>6 17</td>
<td>6 24</td>
<td>mV</td>
</tr>
<tr>
<td>Adjustment Range</td>
<td>$Circuit\ of\ Figure\ 1$</td>
<td>±1</td>
<td>±1</td>
<td>V</td>
</tr>
<tr>
<td>Reverse Dynamic Impedance</td>
<td>$I_R=1\ mA$</td>
<td>0.8 1.6</td>
<td>0.8 2.5</td>
<td>Ω</td>
</tr>
<tr>
<td>Long Term Stability</td>
<td>$T_A=25˚C\pm 0.1˚C$, $I_R=1\ mA$, $t=1000\ hrs$</td>
<td>20</td>
<td>20</td>
<td>ppm</td>
</tr>
</tbody>
</table>

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its specified operating conditions.

Note 2: For elevated temperature operation, $T_j$ max is:
- LM136: 150˚C
- LM236: 125˚C
- LM336: 100˚C

Thermal Resistance

<table>
<thead>
<tr>
<th>$\theta_{ja}$ (Junction to Ambient)</th>
<th>TO-92</th>
<th>TO-46</th>
<th>SO-8</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>180˚C/W (0.4” Leads)</td>
<td>170˚C/W (0.125” Leads)</td>
<td>180˚C/W</td>
</tr>
<tr>
<td>$\theta_{ja}$ (Junction to Case)</td>
<td>N/A</td>
<td>80˚C/W</td>
<td>N/A</td>
</tr>
</tbody>
</table>

Note 3: Unless otherwise specified, the LM136-5.0 is specified from $-55˚C\leq T_A\leq 125˚C$, the LM236-5.0 from $-25˚C\leq T_A\leq 85˚C$ and the LM336-5.0 from $0˚C\leq T_A\leq 70˚C$.

Note 4: Temperature stability for the LM336 and LM236 family is guaranteed by design. Design limits are guaranteed (but not 100% percent production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels. Stability is defined as the maximum charge in $V_{REF}$ from 25˚C to $T_A$ (min) or $T_A$ (max).
Typical Performance Characteristics

Reverse Voltage Change

![Graph showing reverse voltage change with temperature variations.](00571617)

Zener Noise Voltage

![Graph showing zener noise voltage with frequency.](00571618)

Dynamic Impedance

![Graph showing dynamic impedance response time.](00571619)

Response Time

![Graph showing response time with input and output voltage swings.](00571620)

Reverse Characteristics

![Graph showing reverse current and voltage characteristics.](00571621)

Temperature Drift

![Graph showing temperature drift with voltage.](00571622)
Application Hints

The LM136-5.0 series voltage references are much easier to use than ordinary zener diodes. Their low impedance and wide operating current range simplify biasing in almost any circuit. Further, either the breakdown voltage or the temperature coefficient can be adjusted to optimize circuit performance.

*Figure 1* shows an LM136-5.0 with a 10k potentiometer for adjusting the reverse breakdown voltage. With the addition of R1 the breakdown voltage can be adjusted without affecting the temperature coefficient of the device. The adjustment range is usually sufficient to adjust for both the initial device tolerance and inaccuracies in buffer circuitry.

If minimum temperature coefficient is desired, four diodes can be added in series with the adjustment potentiometer as shown in *Figure 2*. When the device is adjusted to 5.00V the temperature coefficient is minimized. Almost any silicon signal diode can be used for this purpose such as a 1N914, 1N4148 or a 1N457. For proper temperature compensation the diodes should be in the same thermal environment as the LM136-5.0. It is usually sufficient to mount the diodes near the LM136-5.0 on the printed circuit board. The absolute resistance of the network is not critical and any value from 2k to 20k will work. Because of the wide adjustment range, fixed resistors should be connected in series with the pot to make pot setting less critical.

*FIGURE 1. LM136-5.0 with Pot for Adjustment of Breakdown Voltage (Trim Range = ±1.0V Typical)*

*FIGURE 2. Temperature Coefficient Adjustment (Trim Range = ±0.5V Typical)*
Typical Applications

Precision Power Regulator with Low Temperature Coefficient

![Circuit Diagram](image)

* Adjust for 6.25V across R1

5V Crowbar

![Circuit Diagram](image)

Adjustable Shunt Regulator

![Circuit Diagram](image)
Typical Applications (Continued)

Linear Ohmmeter

Op Amp with Output Clamped
Typical Applications (Continued)

Bipolar Output Reference

5.0V Square Wave Calibrator

10V Buffered Reference
Typical Applications (Continued)

Low Noise Buffered Reference

Wide Input Range Reference

$V_{IN} = 7V$ to $40V$

$V_{OUT} = 5.0V$

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Physical Dimensions  inches (millimeters)  unless otherwise noted

TO-46 Metal Can Package (H)
Order Number LM136H-5.0, LM136H-5.0/883, LM236H-5.0, LM136AH-5.0, LM136AH-5.0/883 or LM236AH-5.0
NS Package Number H03H

Small Outline (SO-8) Package
Order Number LM336M-5.0 or LM336BM-5.0
NS Package Number M08A
Physical Dimensions  inches (millimeters) unless otherwise noted (Continued)

Plastic Package (Z)
Order Number LM336Z-5.0 or LM336BZ-5.0
NS Package Number Z03A

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